



June 25, 2010

C8051F990/1/6/7, C8051F980/1/2/3/5/6/7/8/9 Rev. A/B Errata

Errata Status Summary

Errata #	Title	Status	
		Rev A Device	Rev B Device
1	Capacitive sense pin monitor	See Errata Details 1	Fixed
2	CS0MD1 bit mapping	See Errata Details 2	Fixed
3	No ADC Input on P1.4	See Errata Details 3	Fixed
4	SmaRTClock startup time	See Errata Details 4	Fixed
5	Non Sleep Mode Current	See Errata Details 5	Fixed
6	Writes to CRC0CN that initiate a CRC0 operation	See Errata Details 6	Fixed
7	Address 0x0000 of XRAM	Information See Errata Details 7	Information See Errata Details 7
8	POR Supply Monitor for supply voltages greater than 2.4V	Information See Errata Details 8	Information See Errata Details 8

Rev B is recommended for production.

Errata Details

1. Capacitive Sense Pin Monitor

Description: An issue has been identified with the capacitive sense pin monitor function when the device enters Suspend mode. If the pin monitor is enabled, under some circumstances, conversions may be continuously initiated.

Impacts: The Capacitive sense conversion may not complete due to continuously being restarted.

Workaround: Disable all pin monitor functionality (CS0PM = 0x00) before entering Suspend mode.

Resolution: Fixed in Rev B and later.

2. CS0MD1 Bit Mapping

Description: Bit 4 and Bit 5 of CS0MD1 have been incorrectly mapped to Bit 5 and Bit 6.

Impacts: Both the CS0 Digital Polarity Select and the CS0 Double Reset Select function share the same bit (Bit 5) in the CS0MD1 register. This may cause a limitation in functionality if these functions are being used.

Workaround: Since making a change to one of the functions will cause a change to the other function, care should be taken when setting up either function. If Bit 5 and Bit 6 are not written, then the device will follow the default behavior described in the data sheet.

Resolution: Fixed in Rev B and later.

3. No ADC Input on P1.4

Description: An issue has been identified that prevents P1.4 from being routed to the ADC.

Impacts: On C8051F996/7/8/9 devices, P1.4 cannot be used as an analog input for the ADC. This behavior does not affect C8051F990/1/2/3/4/5 devices.

Resolution: Fixed in Rev B and later.

4. SmarTClock Startup Time

Description: A modification was made to the SmarTClock crystal driver circuit.

Impacts: The startup time of the SmarTClock crystal oscillator is longer than other devices in the 'F9xx family. Instability may occur at voltages above 3.0 V. The "Oscillator Robustness Test" described in the data sheet is not a valid way to determine oscillator robustness for this silicon revision.

Workaround: Disable automatic gain control or use bias doubling to increase the drive current if the crystal has high ESR (> 40 kΩ) or if the supply voltage is greater than 3.0 V.

Resolution: Fixed in Rev B and later.

5. Non Sleep Mode Current

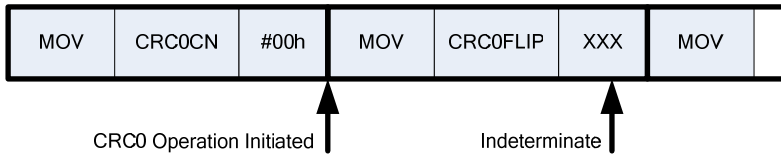
Description: An internal pull-up transistor is enabled, drawing approximately 100 μA, when the precision oscillator is disabled.

Impacts: In all power modes other than Sleep mode, device power consumption will be 100 μA higher than data sheet specifications if the precision oscillator is disabled.

Resolution: Fixed in Rev B and later.

6. Writes to CRC0CN that Initiate a CRC0 Operation

Description: The third op-code byte fetched from program memory following a write to CRC0CN that initiates a CRC0 operation is indeterminate.



Impacts: If the indeterminate op-code byte is the first or second byte in an instruction, improper code execution may result.

Workaround: Writes to CRC0CN that initiate a CRC0 operation must be immediately followed by a benign 3-byte instruction whose third byte is a “don’t care.” An example of such an instruction is the write of a dummy value to the CRC0FLIP register using a 3-byte MOV instruction. The value written to CRC0FLIP will be indeterminate, but this should have no effect on the system. To ensure that both instructions are executed without interruption, global interrupts should be disabled.

Note: When programming in C, the dummy value written to CRC0FLIP should be a non-zero value. This prevents the compiler from generating the following instruction sequence:

```
CLR A
MOV CRC0FLIP, A
```

When programming in C, the disassembly should be checked to ensure the compiler generated the following instruction sequence:

```
MOV CRC0FLIP, #AAh where #AAh is the non-zero dummy value.
```

Resolution: Fixed in Rev B and later.

7. Address 0x0000 of XRAM

Description: On device reset, or upon waking up from Sleep mode, address 0x0000 of external memory may be overwritten by an indeterminate value. The indeterminate value is 0x00 in most situations.

Impacts: Application data stored at 0x0000 in external memory may be overwritten upon reset or waking up from sleep mode.

Workaround: A dummy variable should be placed at address 0x0000 in external memory to ensure that the application software does not store any data that needs to be retained during sleep or reset at this memory location. The compiler-independent example below shows how to locate a dummy variable at address 0x0000 in external memory.

```
LOCATED_VARIABLE_NO_INIT (reserved, U8, SEG_XDATA, 0x0000);
```

Compiler-independent code requires the use of the compiler_defs.h and c8051F990_defs.h header files supplied in the C:\Silabs\MCU\INC folder after installation of the Silicon Laboratories IDE.

Resolution: This information will be added to the device data sheet.

8. **POR Supply Monitor for supply voltages greater than 2.4 V**

Description: The POR Supply Monitor should not be disabled if the supply voltage is greater than 2.4 V.

Impacts: The lowest power sleep mode current, 10 nA typical, can only be achieved when the supply voltage is less than 2.4 V. The lowest power sleep mode for voltages above 2.4 V is 50 nA typical, with the POR Supply Monitor enabled.

Resolution: This information will be added to the device data sheet.